ASSOCIATION CONNECT	© Copyright 2005. IPC, I	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distributed														
Supplier Infor	rmation															
Company name*			Company unique ID			Ţ	Unique ID Authority					Response Date*				
nsemi												2025-08-01				
Contact Name		Title - Contact			I	Phone - Contact*					Email - Contact*					
Product-Env-Stev	wards		Product Enviro Compliance]	NA				Produ	Product-Env-Stewards@onsemi.com				
uthorized Repre	esentative*		Title - Representative			I	Phone - Representative*				Email	Email - Representative*				
Product-Env-Stev	wards		Product Enviro Compliance			1	NA				Produ	Product-Env-Stewards@onsemi.com				
Reque	ster Item Number	Mfr Item 1	em Number Mfr Item Name				Effective Date	Version	M	Manufacturing Site		Weight*		UOM	Unit Type	
		NC7SZ57	Z57L6X UHS 2-Input Logic		gic Gate	2025-08-0			TH	ТНВ		2.09		mg	Each	
Ianufacturin	g Proccess Information															
Termina	Terminal Plating / Grid Array Material		Terminal Base Alloy J.		J-STD-020 MS	SL Rating	Peak Process Body Temperature		Max Time at	ne at Peak Tempera		Number	of Reflow Cyc	eles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		С		seco	nds	3			
Comments																
vel 1 - maximum	n time at peak temperature d	uring sold	lering is 10-3	0 seconds												
or more informa	ation regarding material com	position p	lease refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.04	mg	Supplier	Silicon (Si)	7440-21-3		0.04	mg
Die Attach Tape	0.003	mg	Supplier	Oxirane, (chloromethyl)-, homopolymer	24969-06-0		0.0005	mg
			Supplier	2-Propenoic acid, 2-methyl-, polymer with butyl 2-propenoate and methyl 2- methyl-2-propenoate	25035-69-2		0.0005	mg
			Supplier	Proprietary	Proprietary Data		0.0003	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0013	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0005	mg
Lead Frame	0.803	mg	Supplier	Magnesium (Mg)	7439-95-4		0.001	mg
			Supplier	Silicon (Si)	7440-21-3		0.0063	mg
			В	Nickel (Ni)	7440-02-0		0.0261	mg
			Supplier	Copper (Cu)	7440-50-8		0.7696	mg
Mold Compound-Black	1.207	mg		Epoxy resin	proprietary data		0.0604	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0278	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0604	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0048	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0278	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.026	mg
Plating	0.025	mg	Supplier	Silver (Ag)	7440-22-4		0.0001	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0002	mg
			В	Nickel (Ni)	7440-02-0		0.0247	mg
			Supplier	Gold (Au)	7440-57-5		0.0001	mg
Wire Bond	0.012	mg	Supplier	Palladium (Pd)	7440-05-3		0.0002	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0117	mg